PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Wai Hong Chan	02/01/2008

RECEIVING PARTY DATA

Name:	Sunrich Manufactory Ltd	
Street Address:	14/F Century Industrial Building	
Internal Address:	Shek Pai Tau Road	
City:	Tuen Mun, New Territories	
State/Country:	HONG KONG	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29318159

CORRESPONDENCE DATA

Fax Number: (914)684-0304

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 914-684-0600 Email: sean@lilling.com

Correspondent Name: Sean Liam Kelleher Kelleher & Lilling PL

Address Line 1: P.O. BOX 560

Address Line 4: GOLDEN BRIDGE, NEW YORK 10526

ATTORNEY DOCKET NUMBER:	307/6
NAME OF SUBMITTER:	Sean L. Kelleher

Total Attachments: 3

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> **PATENT** REEL: 020947 FRAME: 0537

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ASSIGNMENT OF PATENT APPLICATION

Whereas, I, the below named inventors, have invented certain new and useful

improvements for an Invention entitled:

Clip-On Booklight

for which an application for a United States Letters Patent has been filed.

Whereas, SUNRICH MANUFACTORY LTD., a corporation organized under and

existing by virtue of the laws of Hong Kong, and having a place of business at Units

A,B,C,E,F & G, 14/F, Century Industrial Building, Shek Pai Tau Road, Tuen Mun, New

Territories, Hong Kong (hereinafter "Assignee") is desirous of acquiring the entire right,

title and interest in the same.

Now, therefore, in consideration of the sum of one dollar (\$1.00), and other good

and valuable consideration, the receipt of which is hereby acknowledged, I, the said

inventor, by these presents, do hereby sell, assign and transfer unto said Assignee the full

and exclusive right, title and interest, together with all rights of priority, to the said

Invention in the United States and the entire world and the entire right, title, and interest

in and to any and all Letters Patent which may be granted therefore in the United States

and the entire world, and all divisional, continuing, substitute, and reissue applications for

Letters Patent which have been or shall be filed in the United States of America or

anywhere in the world.

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PATENT

REEL: 020947 FRAME: 0538

The Assignee is hereby authorized to make application for and to receive Letters Patent for said Invention in the USA and any other country in the world in its own name, or in our names, at its election, and consistent with applicable law.

I agree that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, in order to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all original, divisional, continuing, substitute, reissue patent applications on said invention; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said Invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said Invention and for vesting title to said Invention, and all applications for patents, in said Assignee, its successors, assigns and legal representatives.

I hereby authorize and request the U.S. Commissioner of Patents and Trademarks and the Patent Offices of all countries of the world to issue said Letters Patent to said Assignee as the assignee of the entire right, title, and interest in and to the same, for its sole use and behoof; and for the use and behoof of its legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by us had this assignment and sale not been made.

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Executed by me on the date below indicated beside my signature.

Full name of sole inventor: Wai Hong CHAN

Citizenship: Hong Kong

Residence: Flat C, 19/F. Block 10, Grand Pacific Height, Palatial

Coast, Siu Lam, Tuen Mun, New Territories, Hong Kong

Signature: Date: Feb. 1, 2008